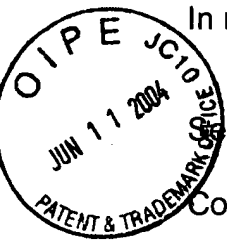




IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



In re Application of:  
Huang, et al.

Serial No.: 09/270,039

Confirmation No.: 1949

Filed: March 16, 1999

For: In Situ Deposition of a Low K  
Dielectric Layer, Barrier Etch  
Stop Layer and Anti-Reflective  
Coating for Damascene  
Application

MAIL STOP AMENDMENT  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

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Group Art Unit: 2823

Examiner: George R. Fourson, III

CERTIFICATE OF MAILING 37 CFR 1.8	
I hereby certify that this correspondence is being deposited on <u>6/7</u> , 2004 with the United States Postal Service as First Class Mail in an envelope addressed to: Mail Stop Amendment Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.	
<u>6/7/04</u> Date	<u><i>Kent R. White</i></u> Signature

**RESPONSE TO OFFICE ACTION DATED MARCH 5, 2004**

In response to the Office Action dated March 5, 2004, having a shortened statutory period for response set to expire on June 5, 2004, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicant believes that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/2966.X3/KMT, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

**Amendments to the Specification** begin on page 2 of this paper. **Amendments to the Claims** are listed on page 4 of this paper. **Remarks** begin on page 8 of this paper.